



STD35NF06

N-channel 60V - 0.018Ω - 35A - DPAK STripFET™ II Power MOSFET

General features

Туре	V _{DSS}	R _{DS(on)}	I _D
STD35NF06	60V	<0.020Ω	35A

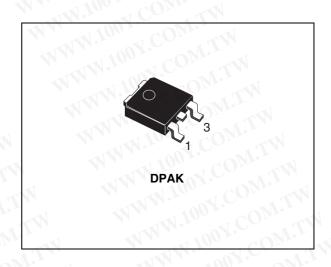
- Exceptional dv/dt capability
- Application oriented characterization
- 100% avalanche tested

Description

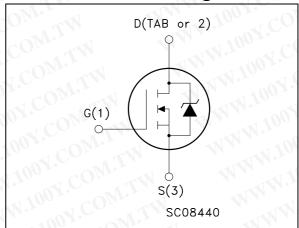
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature SizeTM" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

Applications

Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STD35NF06T4	D35NF06	DPAK	Tape & reel

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Electrical ratings

Absolute maximum ratings Table 1.

Drain-source voltage ($V_{GS} = 0$) Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)	60	V
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)	60	V
		1
Gate- source voltage	± 20	V
Drain current (continuous) at T _C = 25°C	35	Α
Drain current (continuous) at T _C = 100°C	24.5	Α
Drain current (pulsed)	140	Α
Total dissipation at T _C = 25°C	80	W
Derating Factor	0.53	W/°C
Peak diode recovery avalanche energy	5	V/ns
Storage temperature	1003	
Max. operating junction temperature	-55 to 175	°C
	Drain current (continuous) at T _C = 25°C Drain current (continuous) at T _C = 100°C Drain current (pulsed) Total dissipation at T _C = 25°C Derating Factor Peak diode recovery avalanche energy Storage temperature	$\begin{array}{c} \text{Drain current (continuous) at $T_C = 25^{\circ}$C} & 35 \\ \\ \text{Drain current (continuous) at $T_C = 100^{\circ}$C} & 24.5 \\ \\ \text{Drain current (pulsed)} & 140 \\ \\ \text{Total dissipation at $T_C = 25^{\circ}$C} & 80 \\ \\ \text{Derating Factor} & 0.53 \\ \\ \text{Peak diode recovery avalanche energy} & 5 \\ \\ \text{Storage temperature} & -55 \text{ to } 175 \\ \\ \text{Max. operating junction temperature} & -55 \text{ to } 175 \\ \\ \end{array}$

	th limited by safe operating area. di/dt ⊴00A/µs, V _{DD} =V(_{BR)DSS} , T _j ≤T _{JMAX}		
Table 2.	Thermal data		
Rthj-case	Thermal resistance junction-case max	1.88	°C/M
Rthj-amb	Thermal resistance junction-to ambient max	100	°C/W
	Maximum lead temperature for soldering purpose	275	°C

Avalanche characteristics Table 3.

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Symbol	Parameter	Max value	Uni
I _{AR}	Avalanche Current, Repetitive Or Not- repetitive (pulse width limited by T _j max)	17.5	A
E _{AS}	Single pulse avalanche energy (starting T _i = 25 °C, I _D = I _{AR} , V _{DD} = 50 V)	130	mJ

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On/off states Table 4.

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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 250μA, V _{GS} =0	60	ON'L	N	V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} = Max rating, T_{C} = 125°C	100X	COM	1 10	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20V	N.100	J.CC	±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10V, I _D = 17.5A	MW.	0.018	0.020	Ω

Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	7
g _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} > I_{D(on)} x$ $R_{DS(on)max}, I_D = 17.5A$		13	1003	C
C _{iss}	Input capacitance	V 05V 4 1ML		1300	V 700	
C _{oss}	Output capacitance Reverse transfer	$V_{DS} = 25V, f = 1MHz,$ $V_{GS} = 0$		300	111	O F
C _{rss}	capacitance	VGS - 0	e T	105	M.V.	p
t _{d(on)}	Turn-on delay time	V _{DD} = 30V, I _D = 27.5A	N	20		r
C t _r	Rise time	$R_{G} = 4.7\Omega V_{GS} = 10V$		50		r
t _{d(off)}	Turn-off delay time	(see <i>Figure 12</i>)	W	36	M.	r
T _f	Fall time	1100 -001		15		n
Q_g	Total gate charge	$V_{DD} = 48V, I_D = 55A,$	V.	44.5 10.5	60	n
Q_gs Q_gd	Gate-source charge Gate-drain charge	$V_{GS} = 10V, R_G = 4.7\Omega$ (see <i>Figure 13</i>)		17.5		n

^{1.} Pulsed: Pulse duration = 300 μs, duty cycle 1.5%. WWW.100Y.C

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Source drain diode

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W.M	Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
NYN	I _{SD}	Source-drain current Source-drain current (pulsed)	MAN'TOOX'CO	OM.T	CM.	35 140	A A
	V _{SD} (2)	Forward on voltage	$I_{SD} = 35A, V_{GS} = 0$	CODA	M	1.5	V
MA.	t _{rr} Q _{rr} I _{BBM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 35A$, di/dt = 100A/ μ s, $V_{DD} = 20V$, $T_j = 150$ °C (see <i>Figure 14</i>)		75 170 4.5	1	ns μC Α

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^{1.} Pulse width limited by safe operating area.

Pulsed: Pulse duration = 300 µs, duty cycle 1.5% WWW.100Y. WWW.1007.COM.

Electrical characteristics STD35NF06

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

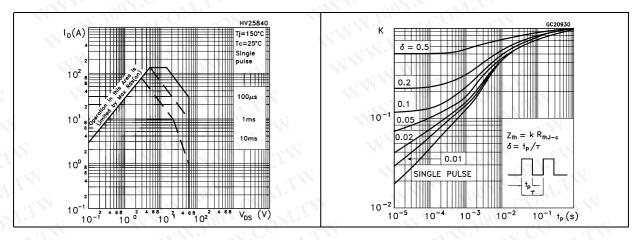


Figure 3. Output characteristics

Figure 4. Transfer characteristics

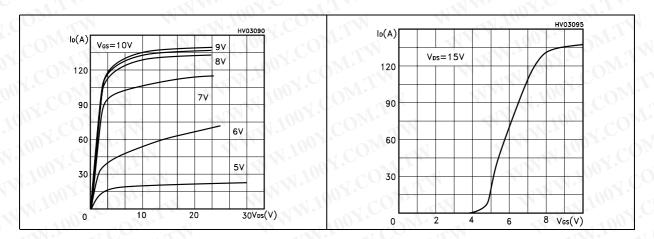
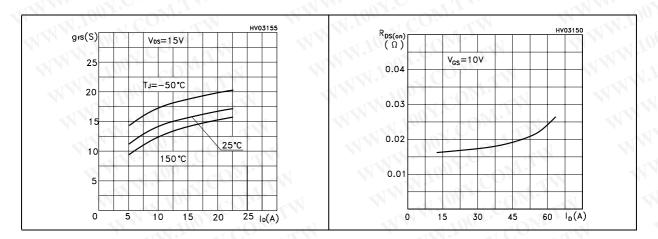


Figure 5. Transconductance

Figure 6. Static drain-source on resistance



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Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations

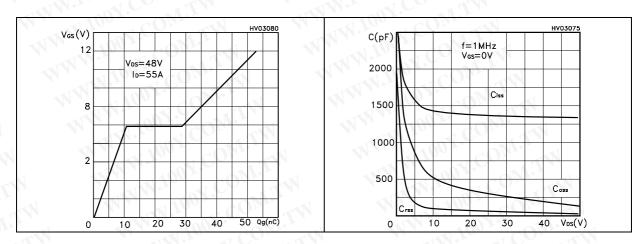


Figure 9. Normalized gate threshold voltage Figure 10. vs. temperature

Figure 10. Normalized on resistance vs. temperature

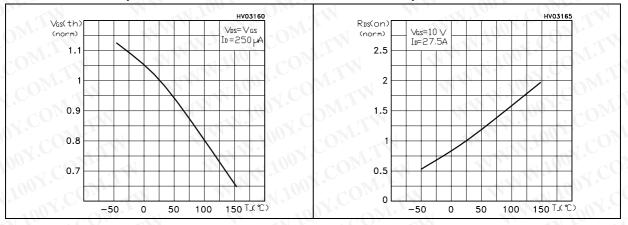
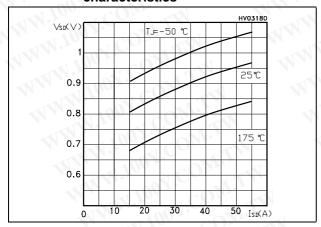


Figure 11. Source-drain diode forward characteristics



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Test circuit STD35NF06

3 Test circuit

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

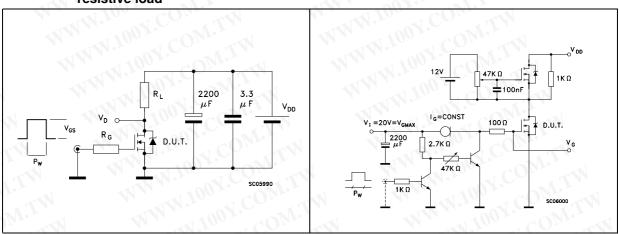


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped Inductive load test circuit

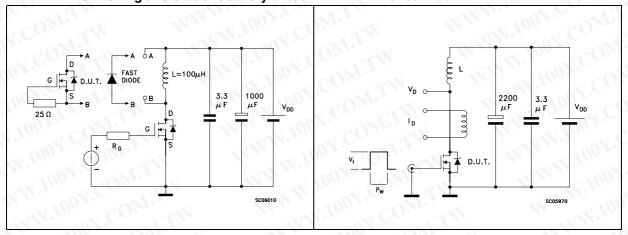
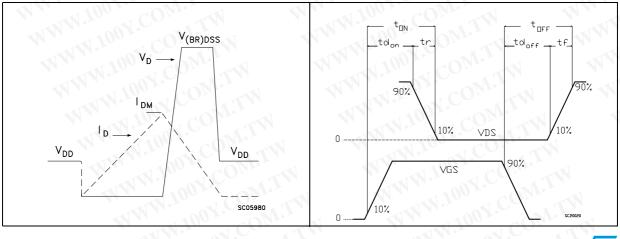


Figure 16. Unclamped inductive waveform

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Figure 17. Switching time waveform



 $M_{M_{\star}}$ M_{100x} $Co_{M_{\star}}$ $M_{M_{\star}}$ M_{100x} $Co_{M_{\star}}$ 2

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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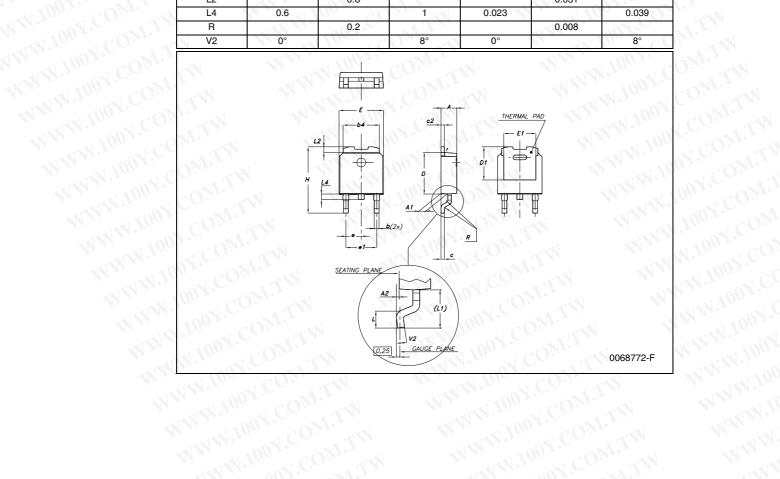
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DIM.		mm.		.007.	inch	
DIM.	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.
Α	2.2	-11	2.4	0.086	ON	0.094
A1	0.9		1.1	0.035		0.043
A2	0.03		0.23	0.001	$CO_{L_{2}}$	0.009
В	0.64		0.9	0.025		0.035
b4	5.2		5.4	0.204	1 CO2	0.212
C	0.45		0.6	0.017	17.	0.023
C2	0.48		0.6	0.019	1 CO 3	0.023
D	6	771.7	6.2	0.236	0.03	0.244
D1	30° -1 C	5.1			0.200	
E	6.4		6.6	0.252	100 J.	0.260
E1	N. I	4.7			0.185	U" , 1
е	100 -	2.28	aT.		0.090	1011.
e1	4.4		4.6	0.173	N. T.	0.181
H	9.35		10.1	0.368	1100 -	0.397
L	1	V.C.		0.039	M.	
(L1)	110	2.8			0.110	40
L2		0.8			0.031	
L4	0.6		1	0.023	10	0.039
R		0.2	12.		0.008	
V2	0°	100	8°	0°	N 1 211	8°



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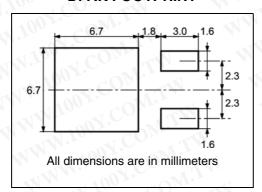
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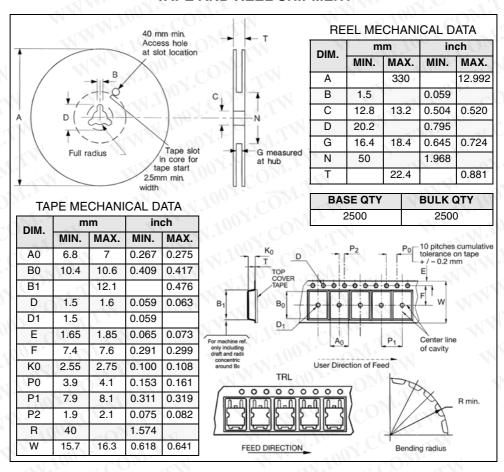
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5 Packing mechanical data

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TAPE AND REEL SHIPMENT



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Revision history WWW.1

Table 7. **Revision history**

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ole 7. Revi	sion history Revision	Changes
21-Jun-2004	2	Preliminary version
06-Jul-2006	3	New template, no content change
20-Feb-2007	4	Typo mistake on page 1

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